

Notice of References Cited	Application/Control No. 10/789,175		Applicant(s)/Patent Under Reexamination CAPPER ET AL.	
	Examiner EDNA WONG		Art Unit 1795	Page 1 of 1

U.S. PATENT DOCUMENTS

*		Document Number Country Code-Number-Kind Code	Date MM-YYYY	Name	Classification
*	A	US-4,581,107	04-1986	Irie et al.	205/155
	B	US-			
	C	US-			
	D	US-			
	E	US-			
	F	US-			
	G	US-			
	H	US-			
	I	US-			
	J	US-			
	K	US-			
	L	US-			
	M	US-			

FOREIGN PATENT DOCUMENTS

*		Document Number Country Code-Number-Kind Code	Date MM-YYYY	Country	Name	Classification
*	N	GB 2104920 A	03-1983	United Kingdom	KAMITANI et al.	C25D 3/56
*	O	JP64068488A	03-1989	Japan	MASATO et al.	C25D 3/56
	P	JP 02025600 A	01-1990	Japan	YONEZAWA et al.	C25F 1/04
	Q					
	R					
	S					
	T					

NON-PATENT DOCUMENTS

*		Include as applicable: Author, Title Date, Publisher, Edition or Volume, Pertinent Pages)
	U	Osetrova, "Use of Ethylenediamine in Electroplating", Sbornik Nauchnykh Trudov - Institut Tsvetnykh Metallov im. M. I. Kalinina (no month, 1960), Vol. 33, pp. 396-399. ABSTRACT ONLY.
	V	
	W	
	X	

*A copy of this reference is not being furnished with this Office action. (See MPEP § 707.05(a).)
Dates in MM-YYYY format are publication dates. Classifications may be US or foreign.